

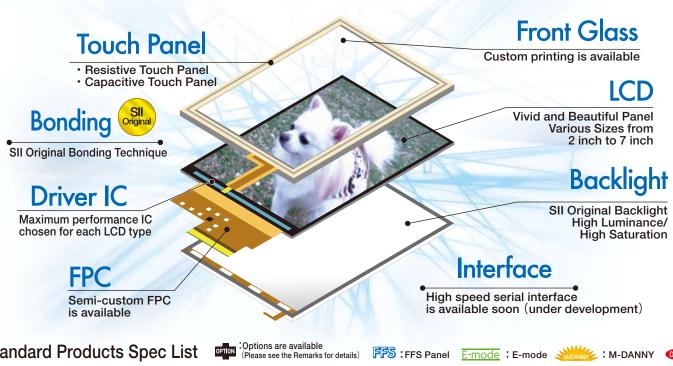




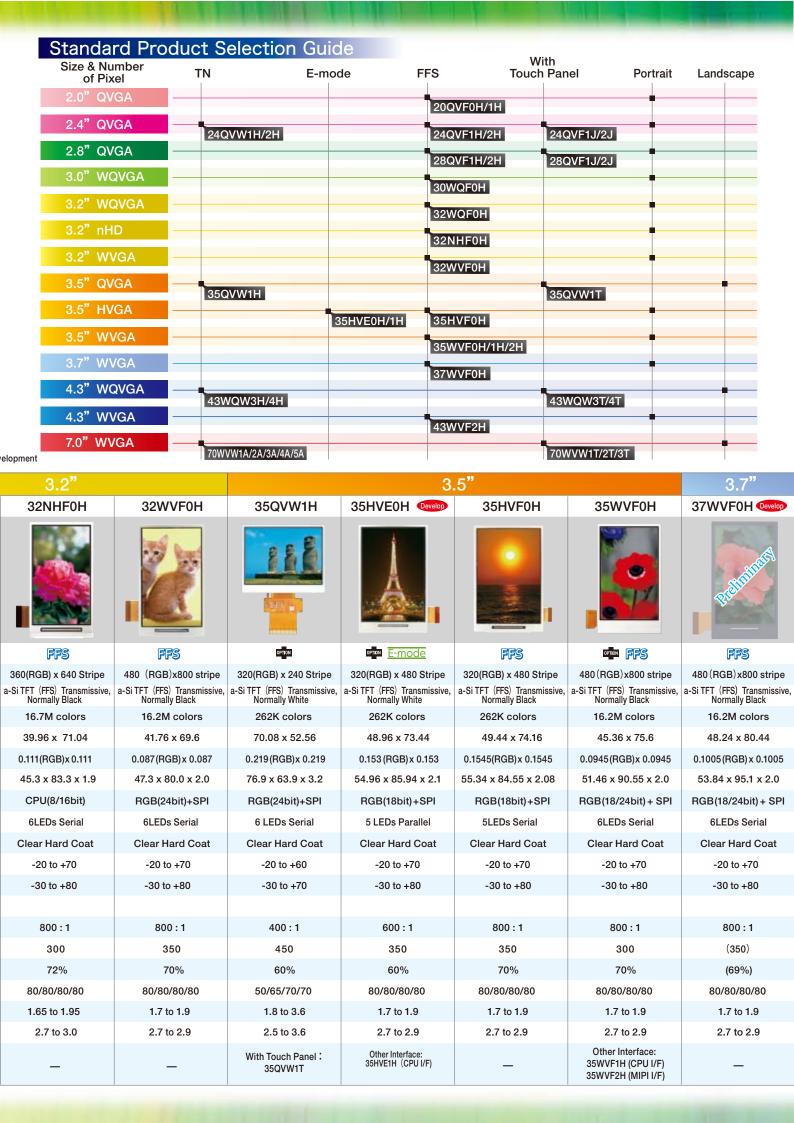
Thin packages High brightness High saturation SII's eco-friendly LCD Module

SII's TFT Modules

SII develops, produces and markets TFT standard modules for a broad range of customer applications!



| Standar | Semi-custom FPC is available d Products Spec I | = 10 ii | e available ne Remarks for details) | is available soor | n (under developme | |
|------------------------------------|---|---|--|---|--|--|
| Panel Siz | | | .4" | 2.8" | 3.0" | ANNI |
| Product nan | 0001/5011 | 24QVF1H | 24QVW1H Develop | 28QVF1H | 30WQF0H | 32WQF0H Develop |
| | | | | | | Prathitate |
| General Specifica | ation OPTION FFS | OPTION FFS | OPTION M-DANNY | OPTION FFS | FFS | FFS |
| Number of Pi | . , . , | 240(RGB) x 320 Stripe | 240(RGB) x 320 Stripe | 240(RGB) x 320 Stripe | 240(RGB) x 400 Stripe | 240(RGB) x 400 Stripe |
| Display Mod | de a-Si TFT (FFS) Transmissive, Normally Black | a-Si TFT (FFS) Transmissive, Normally Black | a-Si TFT (TN), Transmissive, Normally White | a-Si TFT(FFS)Transmissive, Normally Black | a-Si TFT (FFS) Transmissive, Normally Black | a-Si TFT (FFS) Transmissiv Normally Black |
| Number of Co | | 262K colors | 262K colors | 262K colors | 262K colors | 262K colors |
| Active Area (W x H) |) mm 30.6 x 40.8 | 36.72 x 48.96 | 36.72 x 48.96 | 43.2 x 57.6 | 39.24 x 65.4 | 41.76 x 69.6 |
| Dot Pitch (W x H) | mm 0.1275 (RGB)x 0.1275 | 0.153(RGB)x 0.153 | 0.153(RGB)x 0.153 | 0.180(RGB)x 0.180 | 0.1635(RGB)x 0.1635 | 0.174(RGB)x 0.174 |
| Module Size (W x H x T | T) mm 35.8 x 54.12 x 1.75 | 42.72 x 60.4 x 1.93 | 42.06 x 60.26 x 2.71 | 49.0 x 69.0 x 2.06 | 44.5 x 77.1 x 1.882 | 47.66 x 82.1 x 1.9 |
| Interface | RGB(16/18bit)+SPI | CPU (8/9/16/18 bit) | CPU (8/9/16/18 bit) | CPU (8/9/16/18 bit) | CPU (8/9/16/18bit) RGB(16/18bit)+SPI | RGB(16/18bit)+SPI |
| Backlight | 3LEDs Serial | 4 LEDs Serial | 3LEDs Serial | 4LEDs Serial | 5LEDs Serial | 6LEDs Serial |
| Module Surfa | ace Clear Hard Coat | Clear Hard Coat | Clear Hard Coat | Clear Hard Coat | Clear Hard Coat | Clear Hard Coat |
| Operating Temp. | .(°C) -20 to +70 | -20 to +70 | -20 to +70 | -20 to +70 | -20 to +70 | -20 to +70 |
| Storage Temp. | (°C) -30 to +80 | -30 to +80 | -30 to +80 | -30 to +80 | -30 to +80 | -30 to +80 |
| Optical & Electri Specification | cal | | | | | |
| Contrast Ratio (T | Typ.) 800 : 1 | 800 : 1 | 400 : 1 | 800 : 1 | 800 : 1 | 800 : 1 |
| Luminance cd/m² (IL=2 | 20mA) 350 | 350 | 350 | 350 | 450 | 350 |
| NTSC Ratio (Ty | yp.) 70% | 72% | 50% | 72% | 68% | 68% |
| Viewing Angle (U/D/R/L) C | CR>10 80/80/80/80 | 80/80/80/80 | 70/60/70/70 | 80/80/80/80 | 80/80/80/80 | 80/80/80/80 |
| Input VDD (Digi | gital)V 1.65 to 3.3 | 1.65 to 3.3 | 1.65 to 3.3 | 1.65 to 3.3 | 1.65 to 3.3 | 1.65 to 3.3 |
| Voltage VCI (Anal | alog)V 2.5 to 3.3 | 2.5 to 3.3 | 2.5 to 3.3 | 2.5 to 3.3 | 2.5 to 3.3 | 2.5 to 3.3 |
| Remarks | Other Interface: 20QVF1H(CPU I/F) | Other Interface: 24QVF2H (RGB+SPI I/F) With Touch Panel: 24QVF1J/2J | Other Interface: 24QVW2H (RGB+SPI I/F) | Other Interface: 28QVF2H(RGB+SPI I/F) With Touch Panel:28QVF1J/2J | _ | _ |



Custom and Semi-custom

SII works with custom and semi-custom requests. Speak with your SII representative for details.

FPC/Connector

- Interface
- -RGB, CPU, RGB-SPI, YUV (Under denelopment: LVDS, MDDI, MIPI)
- · Pin Arrangement
- · Connector Type
- · Shape



Touch Panel

- Resistive Touch Panel
- Capacitive Touch Panel

Backlight

- Luminance
- · Frame Shape



Bonding

SII has a unique bonding technique (ADB: Airless Direct Bonding) which enables better optical and mechanical performance. We also offer custom bonding with client specific touch panels or front glass overlays.











SII's High quality TFT modules

| 4. | 3" | 7.0" | | | | |
|---|--|---|---|---|---|------------------------------------|
| 43WQW3H/4H | 43WVF2H Develop | 70WVW1A | 70WVW2A/3A | 70WVW4A | 70WVW5A Develop | Product name |
| | | WOOM CANA | | | Pigathilite | |
| OPTION | FFS | ОРПОМ | OPTION | | | General Specification |
| 480(RGB) x 272 Stripe | 480(RGB) x 800 Stripe | 800(RGB) x 480 Stripe | 800(RGB) x 480 Stripe | 800(RGB) x 480 Stripe | 800(RGB) x 480 Stripe | Number of Pixel |
| a-Si TFT (TN) Transmissive, Normally White | a-Si TFT (FFS) Transmissive, Normally Black | a-Si TFT (TN) Transmissive, Normally White | a-Si TFT(TN)Transmissive, Normally White | a-Si TFT (TN) Transmissive, Normally White | a-Si TFT (TN) Transmissive, Normally White | Display Mode |
| 16.2M colors | 16.2M colors | 16.2M colors | 262K colors | 262K colors | 262K colors | Number of Color |
| 95.04 x 53.856 | 56.16 x 93.60 | 152.4 x 91.44 | 152.4 x 91.44 | 152.4 x 91.44 | 152.4 x 91.44 | Active Area (W x H) mm |
| 0.198 (RGB) x 0.198 | 0.117 (RGB) x 0.117 | 0.1905(RGB) x 0.1905 | 0.1905(RGB) x 0.1905 | 0.1905(RGB) x 0.1905 | 0.1905(RGB) x 0.1905 | Dot Pitch (W x H) mm |
| 105.5 x 67.2 x 3.2 | 61.66 x 108.2 x 2.0 | 165.0 x 105.8 x 3.35 | 165.0 x 105.8 x 3.35 | 165.2 x 105.9 x 4.85 | TBD | Module Size (W x H x T) mm |
| RGB(24bit)+ SPI | RGB(18/24bit) + SPI | RGB(24bit) | RGB(18bit) | RGB(18bit) | LVDS(6bit or 8bit) | Interface |
| 4 LEDs Serial x 2 | 8 LEDs Serial | 8 LEDs Serial x 3 | 8 LEDs Serial x 3 | 7 LEDs Serial x 3 | TBD | Backlight |
| Clear Hard Coat | Clear Hard Coat | Anti Glare Coat | Anti Glare Coat | Anti Glare Coat | Anti Glare Coat | Module Surface |
| -20 to +60 | -20 to +70 | -20 to +70 | -20 to +70 | -20 to +70 | -20 to +70 | Operating Temp. (c) |
| -30 to +70 | -30 to +80 | -30 to +80 | -30 to +80 | -30 to +80 | -30 to +80 | Storage Temp. (c) |
| | | | | | | Optical & Electrical Specification |
| 400 : 1 | 800 : 1 | 400 : 1 | 400 : 1 | 400 : 1 | 400 : 1 | Contrast Ratio (Typ.) |
| 250/350 | 450 | 450 | 450/350 | 350 | TBD | Luminance cd/m² (IL=20mA) |
| 50% | 72% | 45% | 45% | 45% | 45% | NTSC Ratio (Typ.) |
| 50/65/70/70 | 80/80/80/80 | 55/65/70/70 | 55/65/70/70 | 55/65/70/70 | 55/65/70/70 | Viewing Angle (U/D/R/L) CR>10 |
| 1.7 to 3.6 | 1.7 to 1.9 | Vcc : 3.0 to 3.6 | Vcc : 3.0 to 3.6 | Vcc : 3.0 to 3.6 | Vcc : (3.0 to 3.6) | VDD (Digital) V Input |
| 2.5 to 3.6 | 2.7 to 2.9 | ¥00 . 0.0 to 0.0 | ¥00 . 0.0 to 0.0 | 100 . 0.0 10 0.0 | | VCI (Analog)V Voltage |
| With Touch Panel: 43WQW3T/4T | _ | With Touch Panel: 70WVW1T | With Touch Panel: 70WVW2T/3T | Long-life LED backlight | _ | Remarks |

Thin package, High brightness, High saturation SII's eco-friendly LCD Module

Advanced Technical Information

LCD

LCD panel type

SII manufactures a variety of LCD module types - providing clients the best options for their intended applications.

| LCD Panel | TN | TN-W | E-mode | FFS |
|---------------|--------------------|-----------------|--------------|---------------------------|
| Туре | Twisted Nematic | TN-Wide View | TN E-mode | Fringe Field Switching |
| Contrast | Better | Better | Better | Best |
| Thinness | Best | Good | Better | Best |
| Viewing Angle | Good | Good | Better | Best |



*They might be different from the LCDs actually seer





The wide viewing angle and enhanced contrast ratio of the FFS technology displays offer minimal color-shifting at the outer boundaries of the display's viewing angle.

Unique Bonding

SII has a unique bonding technique ADB (Airless Direct Bonding). ADB enables low-cost but high-quality bonding. We also offer custom bonding with client specific touch panels or front glass overlays.

Features High Sunlight Readability

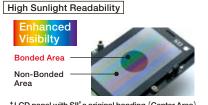
SII's LCD direct bonding process ensures very good sunlight readability by effectively managing reflectivity.

SII's Bonding process enables both a thin and strong LCD module.

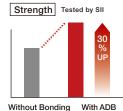
High Reliability /Durability

SII's Bonding process increases the impact strength of the LCD Module.

SII's Bonding process eliminates dust between the LCD and font glass/touch panel.

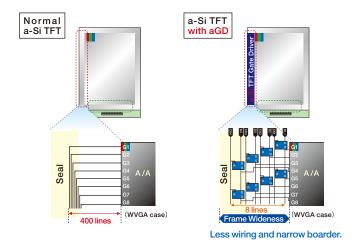


†LCD panel with SII's original bonding (Center Area)



aGD(a-Si Gate Driver)

aGD (a-Si Gate Driver) enables high definition and compact LCD module.



Capacitive Touch Panel

Capacitive Touch Panel Structure

Cover Window

Bonding

(ADB)

SII develops, produces and markets capacitive touch panel modules - either integrated with one of our LCD Modules or as a stand-alone product offering.

Features

Controller IC Mounting

SII prepares the most suitable controller IC for client's application. Multi-touch or gesture is available depend on the controller IC.

Shape Customizing

SII processes the glass shape according to client's request.

Bonding Option

Bonding is available with SII's LCD or client specific LCD.

Matching Support with LCD

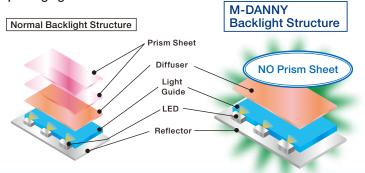
SII supports the matching with LCD including noise cancellation.

Backlight

Choose best LCD with SII's original backlight "M-DANNY" and "Ti-SOL"!

M-DANNY

Simple structure without a prism sheet. M-DANNY enables an even light distribution and clear LCD panel, while offering slim packaging.

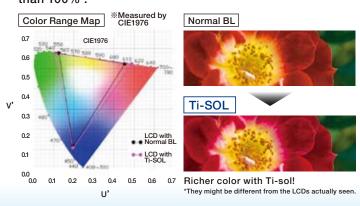


ITO Sensor

(Glass/PET)

SII's original Ti-SOL film widens the NTSC ratio more than 100%*.

Controller IC



Environmental Activities

SII Group Environmental Policy

Environmental Concept

As a good corporate citizen, the SII Group will continue to harmonize its corporate activities with the global environment, protect and improve the environment, and contribute to the establishment of a sustainable society that can coexist with all nature.

(SII LCD Environmental Policy)

SII LCD Device is implementing the energy-saving actions, the reduction of waste, the reduction of hazardous materials, the effective use of paper resources and the development of environmental friendly products based on the SII Group Environmental Policy.

[Four Specific Actions to Protect the Environment from SII LCD Device]

1.Energy Saving

· Energy Saving in Manufacturing Process

Our factories, which manufacture our products, are implementing energy saving procedures in their manufacturing process.

Energy Saving through Low Power Consumption
 By design, LCD Device is an energy saving product. We are continuously improving.
 Our products for lower current consumption, resulting in further energy saving.



This mark means that the product complies with SII's own environmental standards.

2. Resource Saving

We set the resource saving targets and control the amount of raw materials, water used in processing, office resource and indirect materials in both the factory and our administrative offices.

3. Manufacturing an Environmentally Friendly Product

• RoHS Compliance*1 and other nations' directive (including REACH: Registration, Evaluation, Authorization and restriction of Chemicals)
Before adopting new materials or processes, we make sure the material or process is not using any prohibited or restricted materials
including RoHS designation. (The RoHS Directive has some exemptions. Some materials might be applied to them.)

*1 The RoHS Directive stands for: [The Restriction of the use of certain Hazardous Substances in Electrical and Electronic Equipment] This is a directive which the EU (European Union) set for the restriction of the use of certain hazardous substances in electrical and electronic device and equipment, and it was issued in February 2003 together with the WEEE Directive. Accordingly, the directive has banned the use of the certain 6 substances in EU member nations since July 2006.

· Halogen free

Incinerating Plastics with halogen elements (which also include bromine or chlorine) produce poisonous gases (dioxin). We are addressing the demand for Halogen free products and aim to manufacture these eco-friendly products. (Halogen free products are presently custom only)

Compliant with SII Green Product Label
 To raise public awareness of our eco-friendly products, SII introduced the SII Green Product Label System.

 All the LCD Device products satisfy certain criteria and are certified as SII Green Products.

4.Green Purchase

We promote "Green Purchase" along with "Green Purchase Guidelines". These are two innovative programs established by SII Group.



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(Specifications are subject to change without notice.)

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